

Features

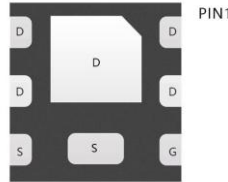
- Trench Power LV MOSFET technology
- High Power and Current handling capability
- Low Gate Charge

Product Summary

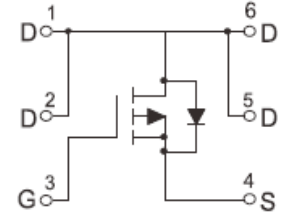
V_{DS}	$R_{DS(ON)}$ TYP	I_D
-15V	30mΩ@-4.5V	-10A
	38mΩ@-2.5V	

Application

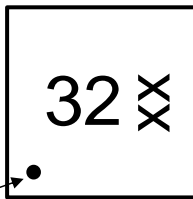
- PWM applications
- Power management
- Load switch



DFN2X2-6L view



Schematic diagram



Pin 1

32: Device code
 XX: Code
 Solid dot: Pin1 indicator

Marking and pin assignment



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
--------	-----------	--------	------

Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-15	V
V_{GS}	Gate-Source Voltage	±10	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ -10	A

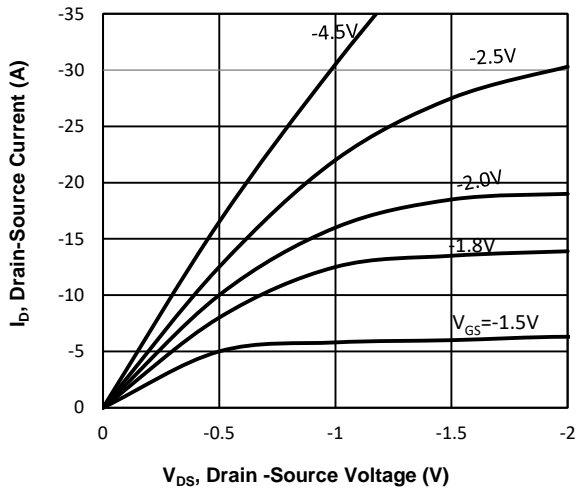
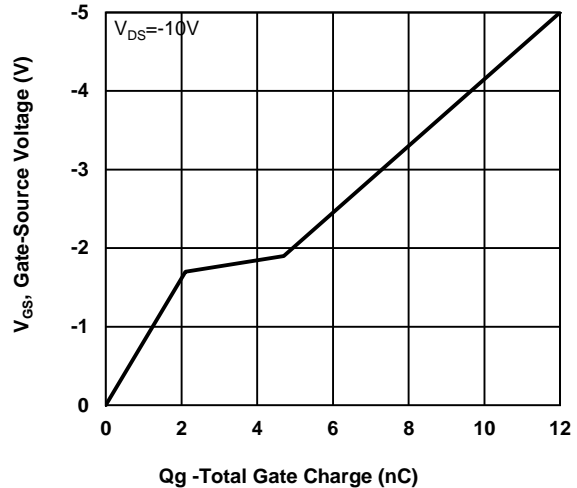
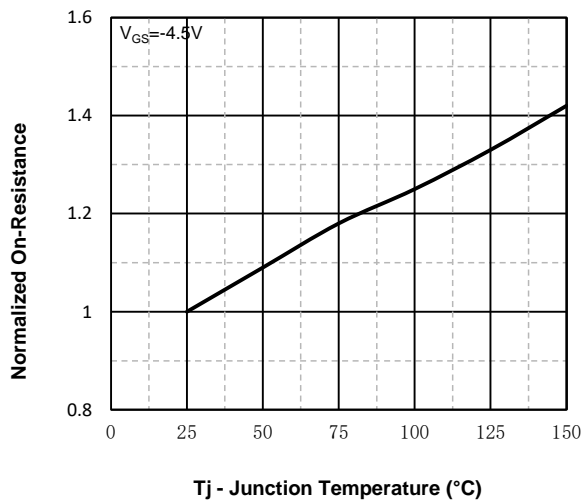
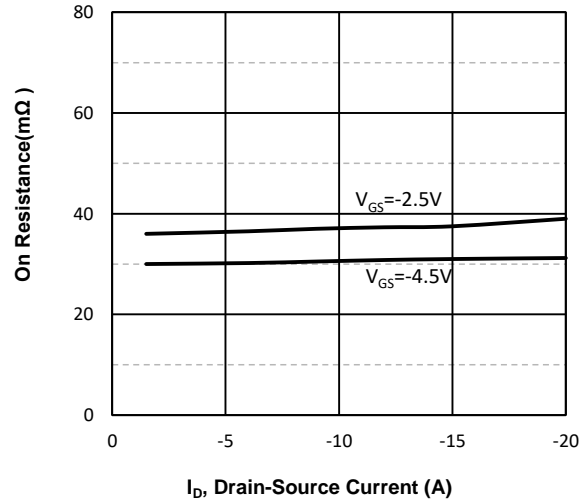
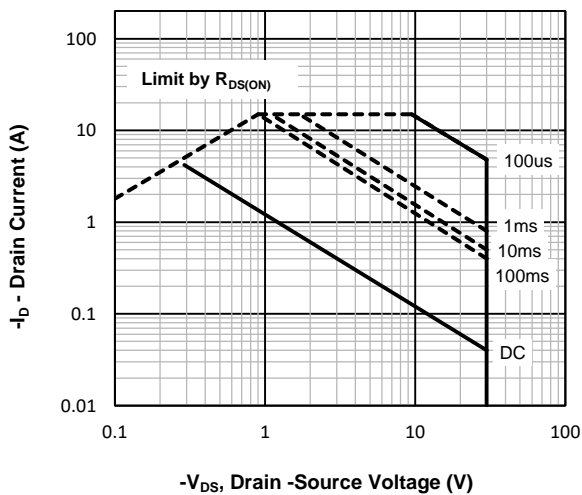
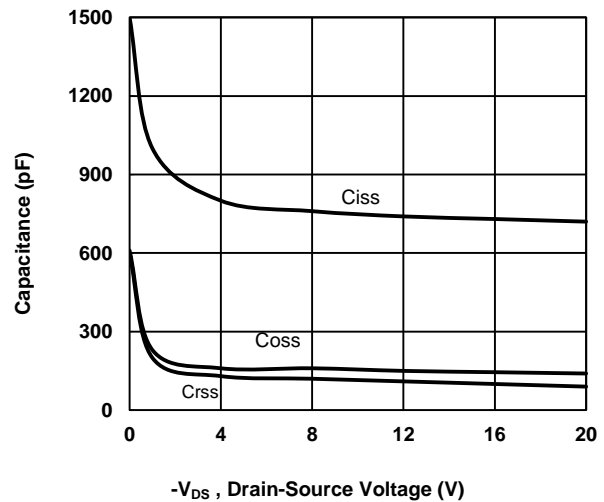
Mounted on Large Heat Sink

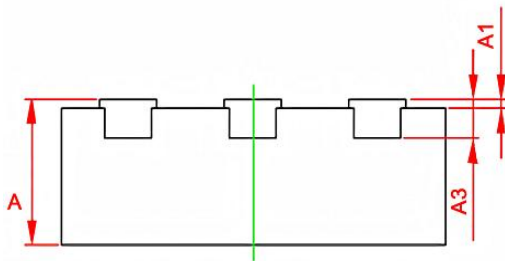
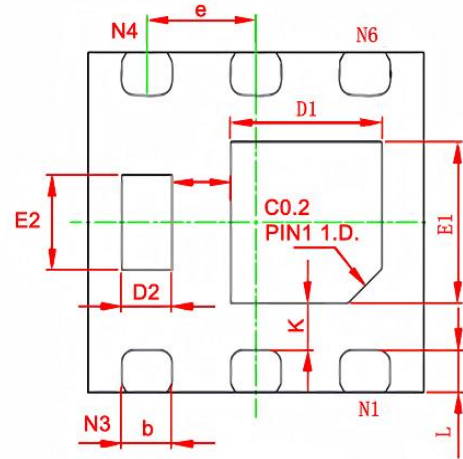
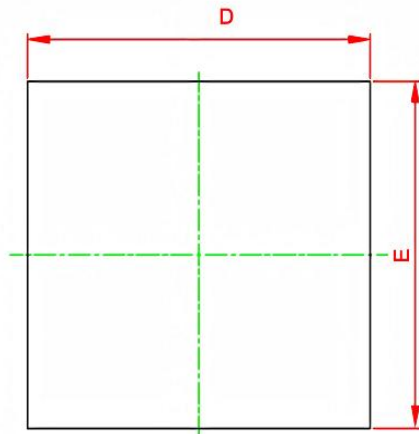
I_{DM}	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ -25	A
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$ -10	A
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 2.2	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient	57	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLSM429C	DFN2X2-6L	32	3,000	45,000	180,000	7" reel

Electrical Characteristics (T _J =25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T _J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-15	-17	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-13V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±10V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.4	-0.62	-1.0	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-4A	--	30	40	mΩ
		V _{GS} =-2.5V, I _D =-2A	--	38	60	mΩ
		V _{GS} =-1.8V, I _D =-1A	--	53	90	mΩ
Dynamic Electrical Characteristics @ T _J = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-4V, V _{GS} =0V, f=1MHz	--	740	--	pF
C _{OSS}	Output Capacitance		--	290	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	190	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =-4V, I _D =-4A, V _{GS} =-2.5V	--	4.3	--	nC
Q _{gs}	Gate Source Charge		--	1.2	--	nC
Q _{gd}	Gate Drain Charge		--	1.5	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-4V, I _D =-3.3A, V _{GEN} =-8V, R _L =1.2Ω	--	5	--	nS
t _r	Turn-on Rise Time		--	11	--	nS
t _{d(off)}	Turn-Off Delay Time		--	22	--	nS
t _f	Turn-Off Fall Time		--	16	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =-4A	--	--	-1.2	V

Typical Operating Characteristics

Fig1. Typical Output Characteristics

Fig2. Typical Gate Charge Vs. Gate-Source Voltage

Fig3. Normalized On-Resistance Vs. Temperature

Fig4. On Resistance Vs. Drain-Source Current

Fig5. Maximum Safe Operating Area

Fig6. Typical Capacitance Vs. Drain-Source Voltage

DFN2X2-6L Package information


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.600	0.700	0.023	0.027
A1	0.000	0.050	0.000	0.001
A3	0.203REF		0.007REF	
b	0.315	0.415	0.012	0.016
D	1.924	2.076	0.075	0.081
E	1.924	2.076	0.075	0.081
e	0.650TYP		0.225TYP	
L	0.224	0.376	0.008	0.014
k	0.200	-	0.007	-
E1	1.000	1.200	0.039	0.047
D1	0.900	1.100	0.035	0.043
E2	0.700	0.900	0.027	0.035
D2	0.150	0.350	0.005	0.013